

Appl. No. 10/015,374  
Amdt. dated March 7, 2005  
Reply to Office Action of December 14, 2004

2826  
JPLW

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant(s): Kwang Seok Oh et al.

Assignee: Amkor Technology, Inc.

Title: STACKING STRUCTURE OF SEMICONDUCTOR CHIPS AND  
SEMICONDUCTOR PACKAGE USING IT

Serial No.: 10/015,374 Filed: December 12, 2001

Examiner: Alexander O. Williams Group Art Unit: 2826

Docket No.: GK0020

Monterey, CA  
March 7, 2005

Mail Stop Amendment  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

AMENDMENT

Dear Sir:

In response to the Office Action dated December 14, 2004,  
please amend the above-identified application as follows:

1. **Amendments to the Claims** are reflected in the  
listing of Claims which begins on page 2 of this paper;  
and
2. **Remarks** begin on page 10 of this paper.